



**Pb-free
HEAT**



5614S Series

Bi-color ϕ 5 Round Shape Type

Features

Package	Bi-color ϕ 5 Round shape type, Milky White Diffused epoxy
Product features	<ul style="list-style-type: none"> • Outer Dimension ϕ5 Round shape type • Operation temperature range. Storage Temperature : -30 ~ 100 Operating Temperature : -30 ~ 85 • Lead-free soldering compatible • RoHS compliant
Dominant wavelength	Green : 558nm (BG) : 567nm (PG) Yellow Green : 572nm (PY) Red : 624nm (VR)
Half Intensity Angle	BG,PG,PY : 24 deg. VR : 21 deg.
Die materials	BG,PG,PY : GaP VR : GaAsP
Rank grouping parameter	Sorted by luminous intensity per rank taping
Soldering methods	TTW (Through The Wave) soldering and manual soldering
ESD	More than 2kV(HBM)
Packing	Bulk : 200pcs(MIN.)

Recommended Applications

Amusement Equipment, Electric Household Appliances, OA/FA, Other General Applications

Color and Luminous Intensity

(Ta=25)

Part No.	Die Name	Material	Emitted Color	Lens Color		Dominant Wavelength		Luminous Intensity		
						λd (nm)		I _v (mcd)		
						TYP.	I _F	MIN.	TYP.	I _F
VRBG5614S	BG	GaP	Green	Milky White	Diffused	558	20	8	16	20
	VR	GaAsP	Red			624	20	15	30	20
VRPG5614S	PG	GaP	Green	Milky White	Diffused	567	20	15	30	20
	VR	GaAsP	Red			624	20	15	30	20
VRPY5614S	PY	GaP	Yellow Green	Milky White	Diffused	572	20	25	50	20
	VR	GaAsP	Red			624	20	15	30	20

Absolute Maximum Ratings

(Ta=25)

Item	Symbol	Absolute Maximum Ratings				Unit
		BG	PG	PY	VR	
Power Dissipation	P_d	75	75	75	75	mW
Forward Current	I_F	30	30	30	30	mA
Pulse Forward Current ※1	I_{FRM}	100	100	100	100	mA
Derating (Ta=25°C or higher)	ΔI_F	0.33	0.33	0.33	0.33	mA/°C
Reverse Voltage	V_R	4	4	4	4	V
Operating Temperature	T_{opr}	-30~+85				°C
Storage Temperature	T_{stg}	-30~+100				°C

1 I_{FRM} Measurement condition : Pulse Width 1ms., Duty 1/20.

The ratings specified above are under the condition that only one diode is lit.

50% Max. of each rating shall be applied when two diodes are lit simultaneously.

Electro-Optical Characteristics

(Ta=25)

Item	Conditions	Symbol	Characteristics				Unit	
			BG	PG	PY	VR		
Forward Voltage	I _F =20mA	V _F	TYP.	2.1	2.1	2.1	2.0	V
			MAX.	2.5	2.5	2.5	2.5	
Reverse Current	V _R =4V	I _R	MAX.	100	100	100	100	μ A
Peak Wavelength	I _F =20mA	λ _p	TYP.	555	560	570	630	nm
Dominant Wavelength	I _F =20mA	λ _d	TYP.	558	567	572	624	nm
Spectral Line Half Width	I _F =20mA	Δλ	TYP.	30	30	30	30	nm
Half Intensity Angle	I _F =20mA	2θ 1/2	TYP.	24	24	24	21	deg.

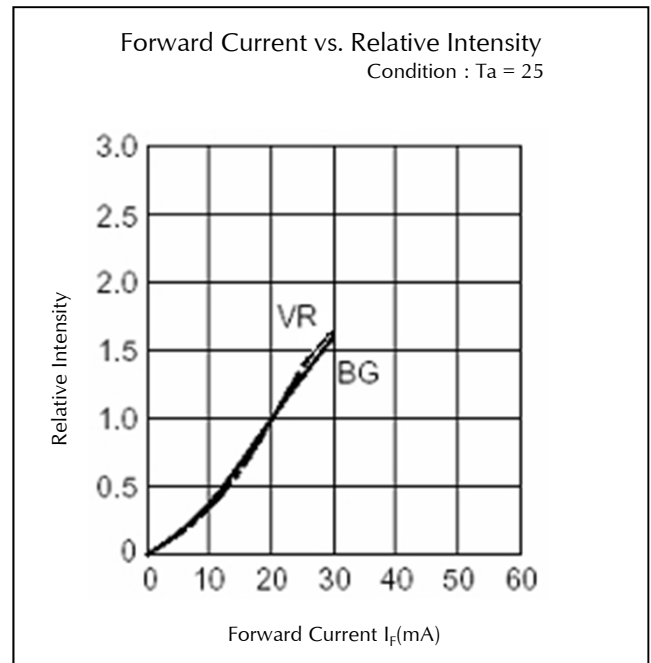
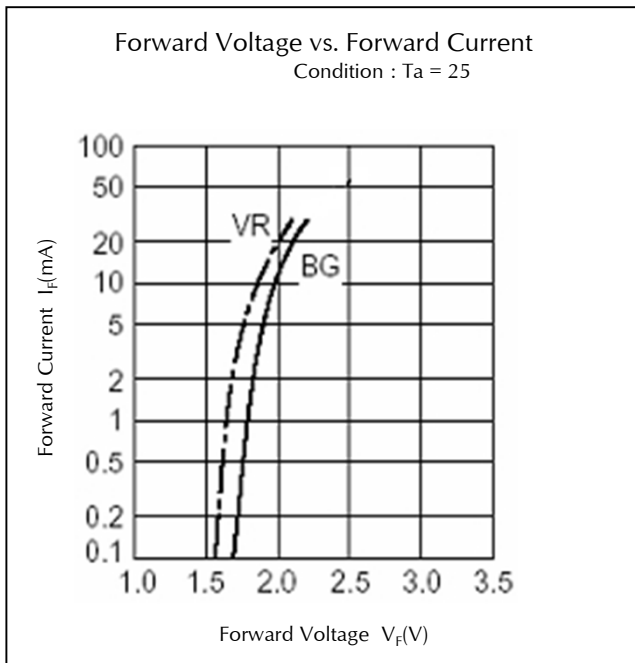
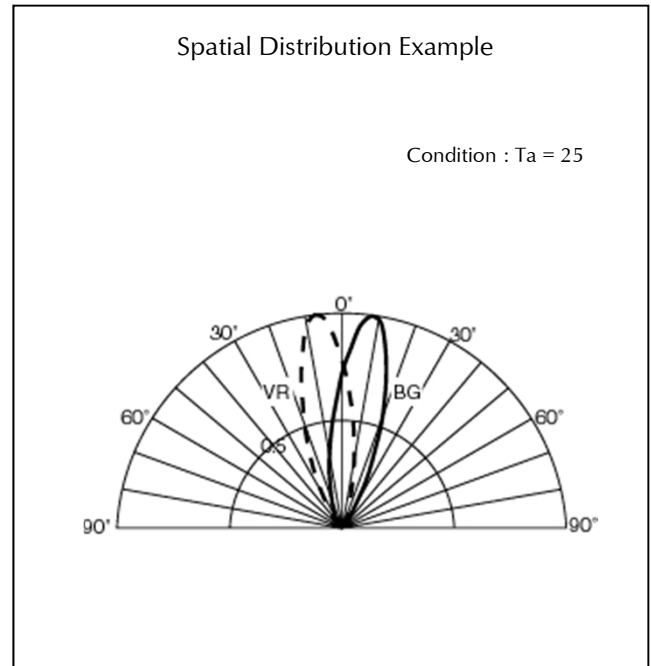
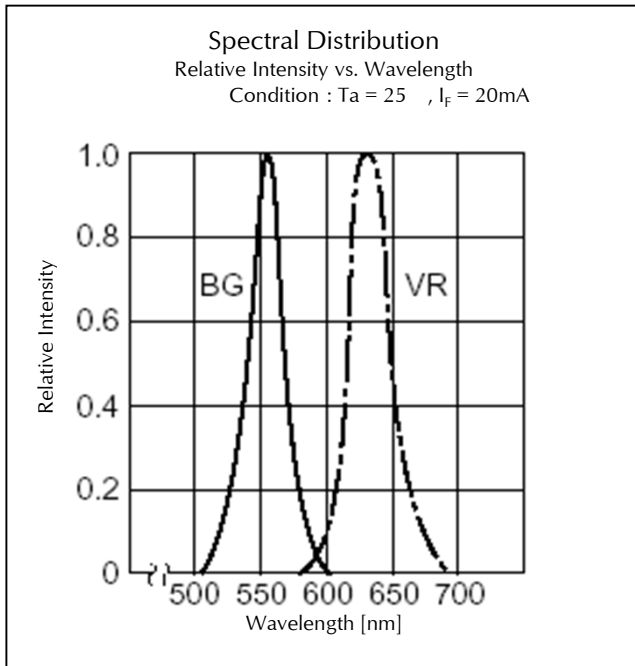
Luminous Intensity Rank

(Ta=25)

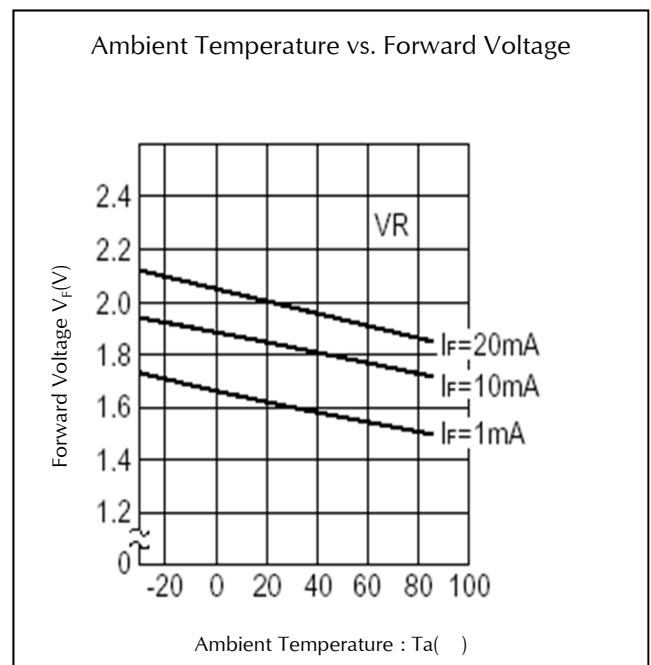
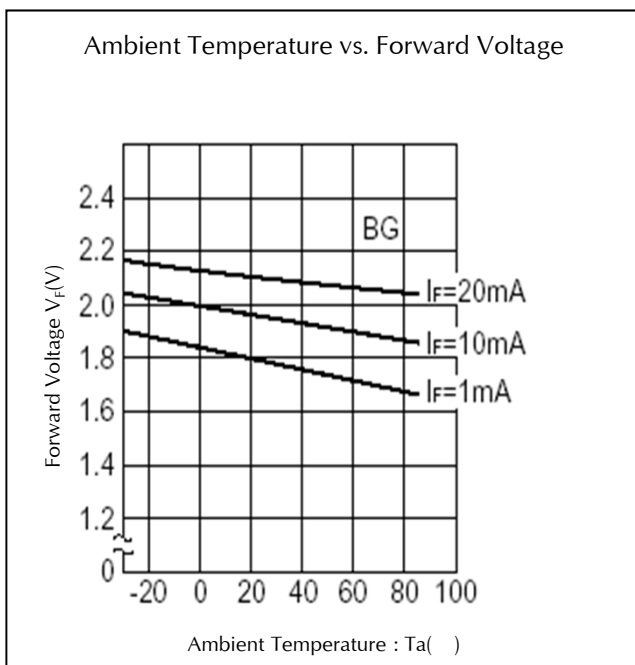
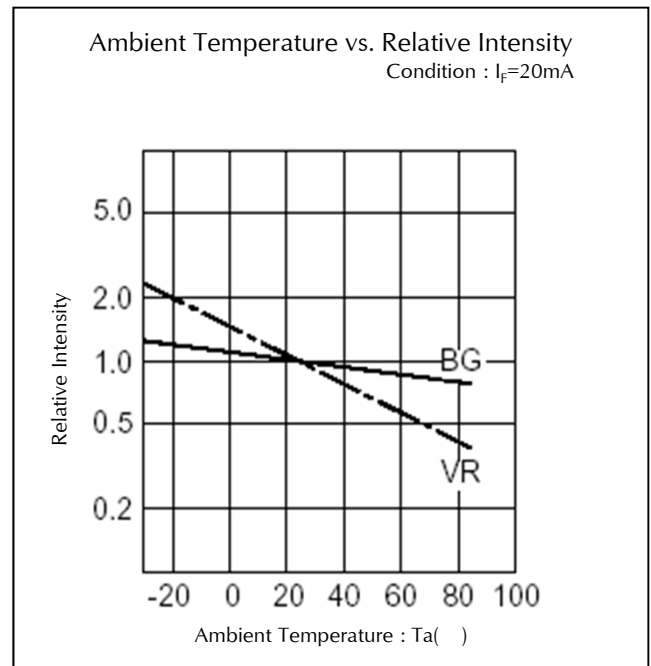
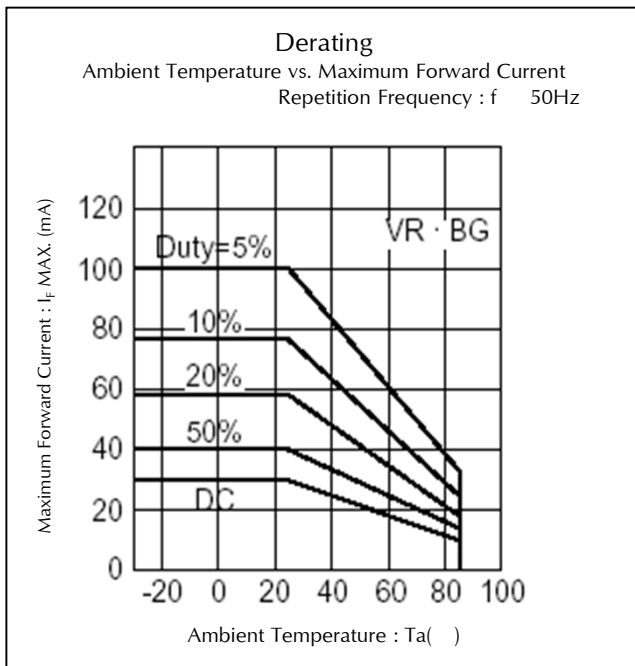
Rank	I _v (mcd)												Condition
	VRBG5614S				VRPG5614S				VRPY5614S				
	BG		VR		PG		VR		PY		VR		
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
AA	8.0	22.4	15.0	42.0	15	42	15	42	25	70	15	42	I _F = 20mA
AB	16.0	44.8	15.0	42.0	30	84	15	42	50	140	15	42	
BA	8.0	22.4	30.0	84.0	15	42	30	84	25	70	30	84	
BB	16.0	44.8	30.0	84.0	30	84	30	84	50	140	30	84	

Please contact our sales staff concerning rank designation.

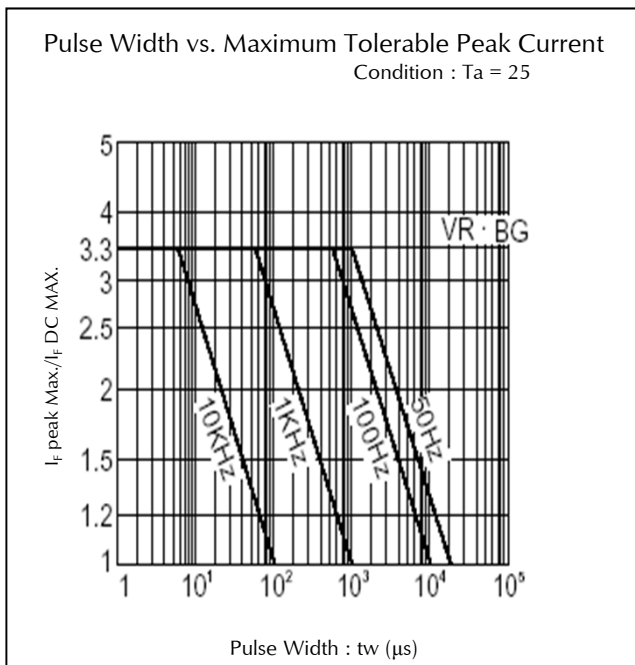
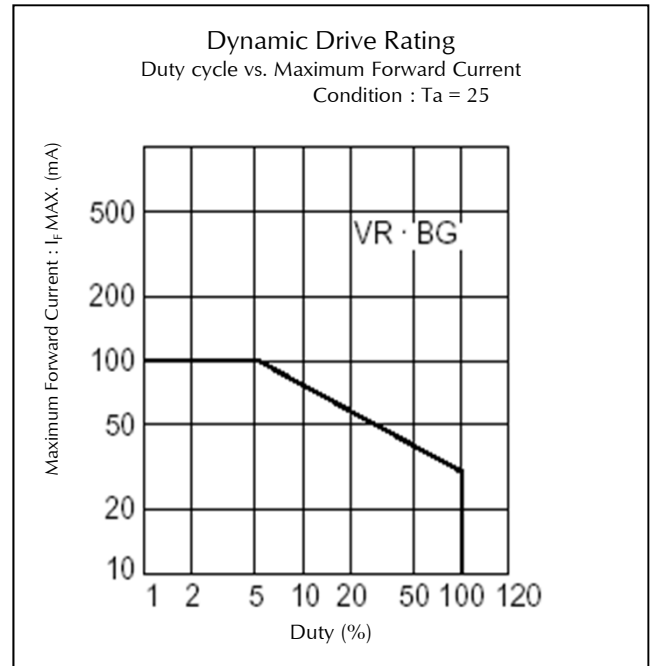
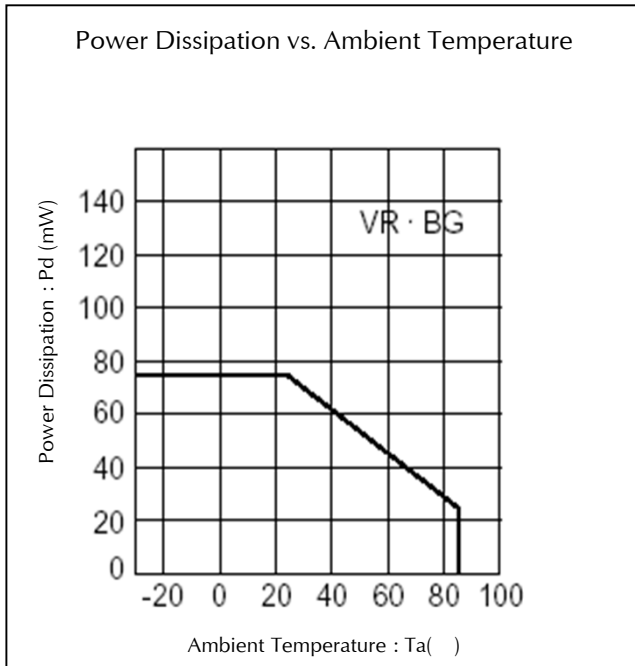
Technical Data(VRBG)



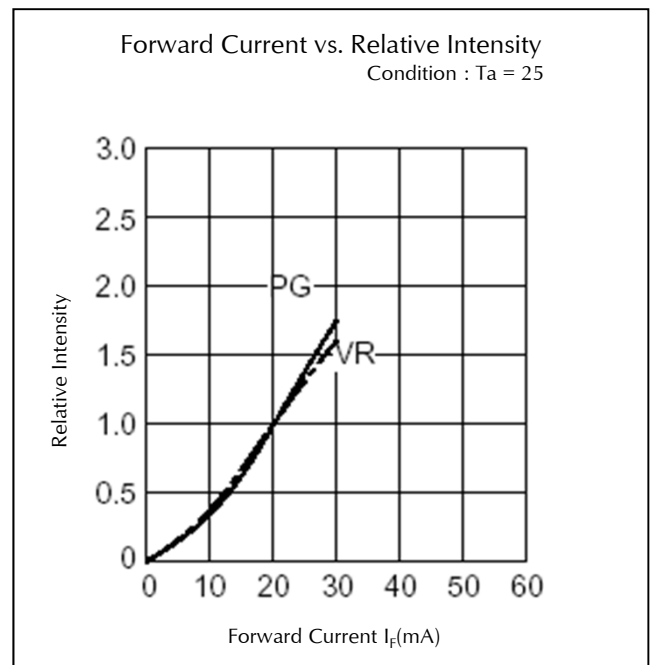
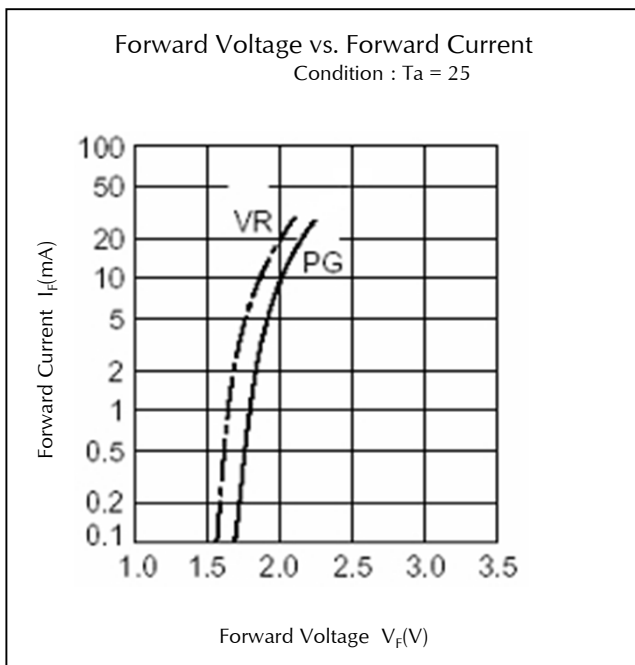
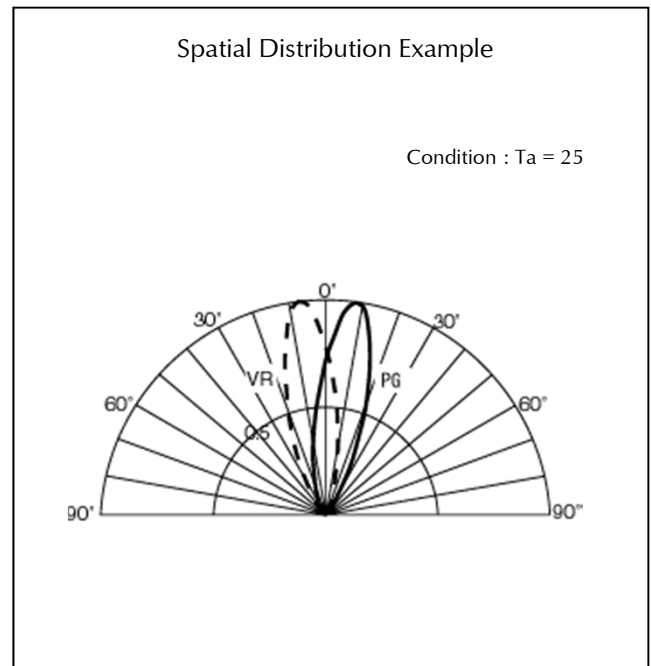
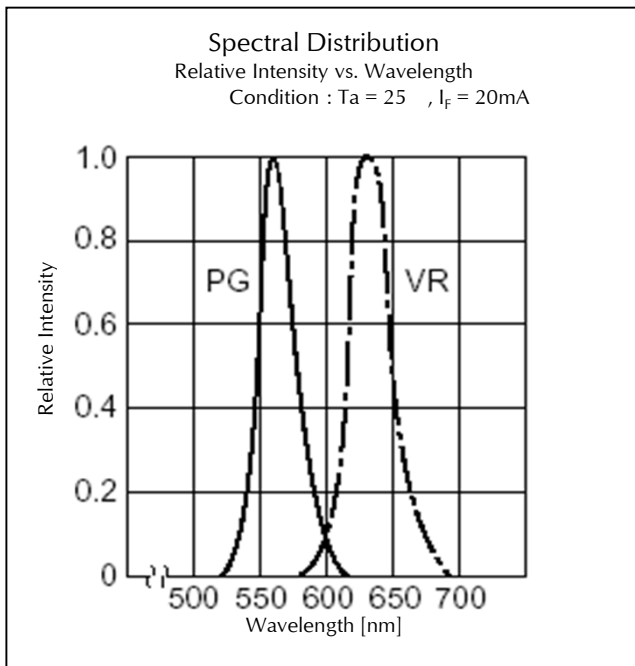
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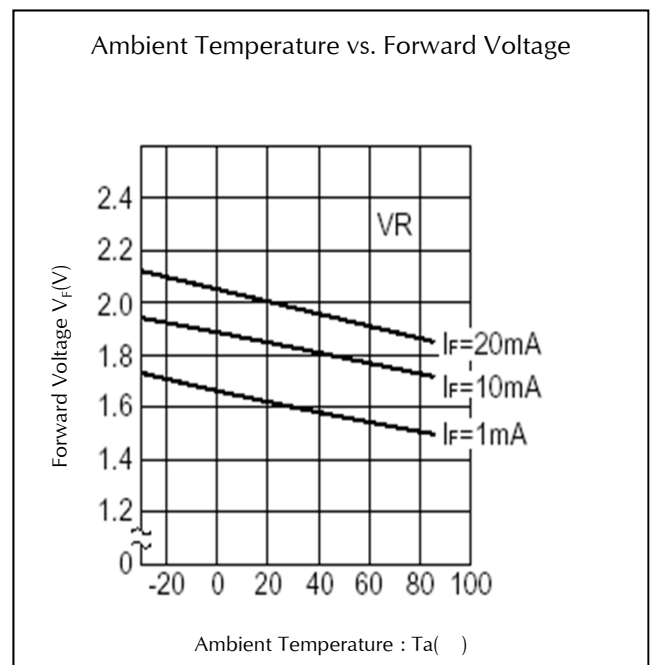
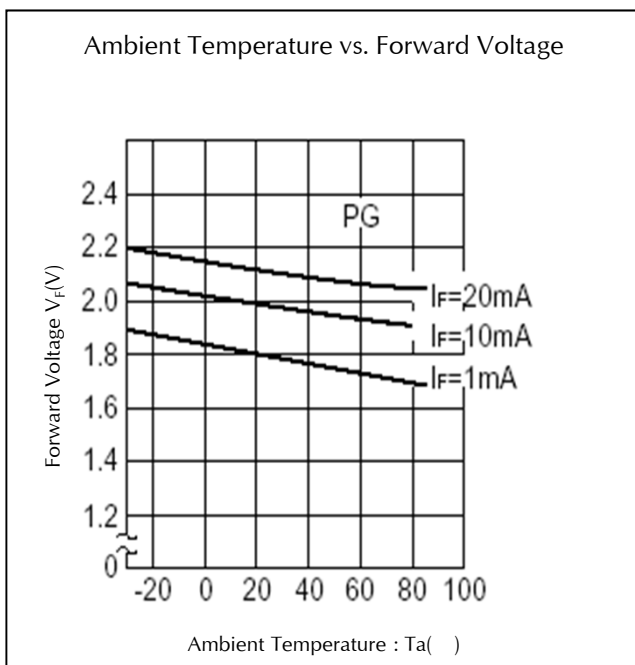
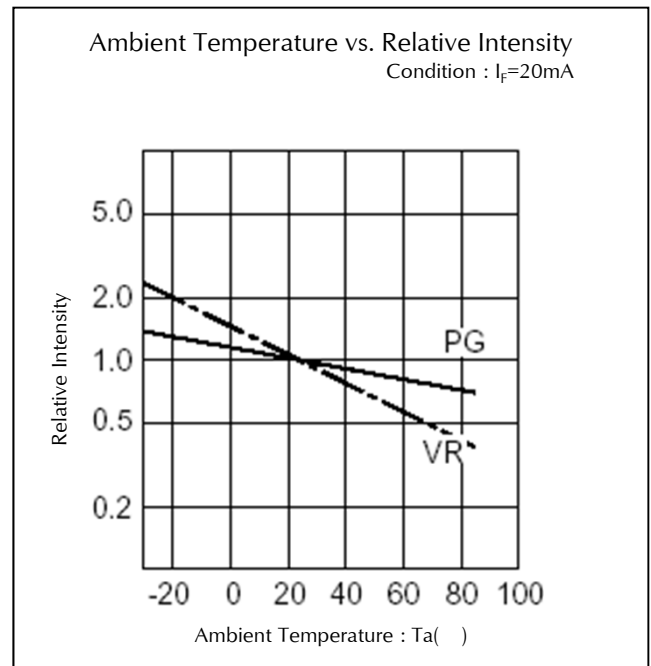
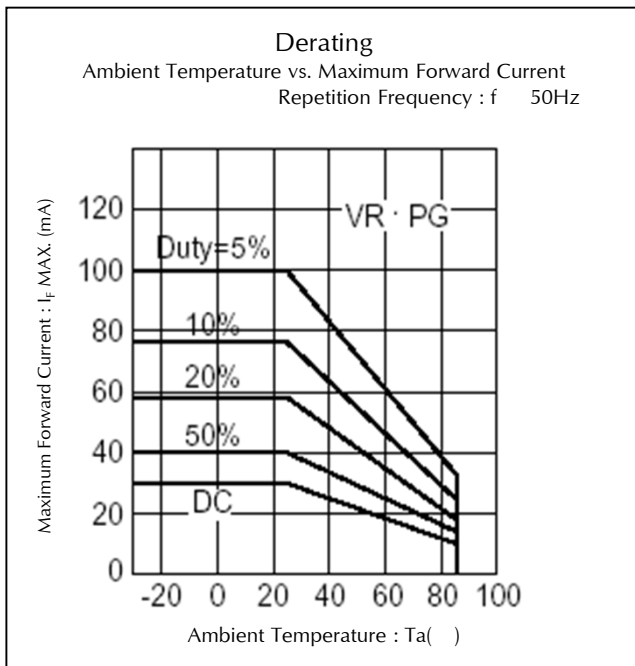
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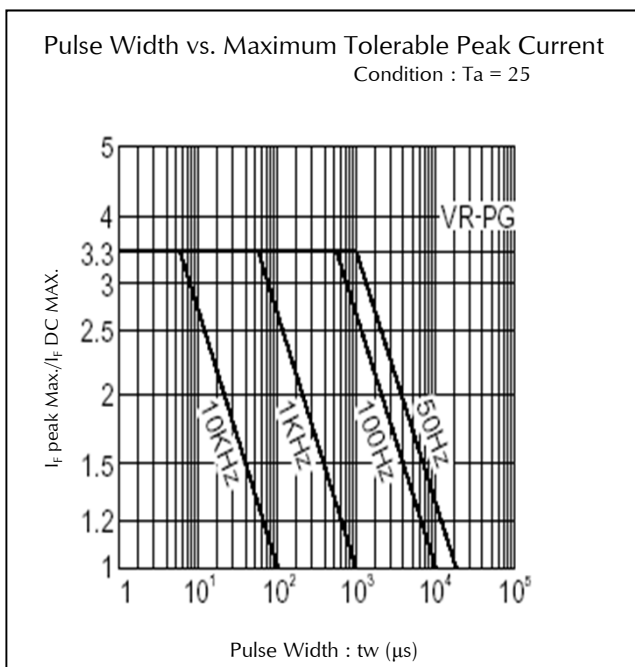
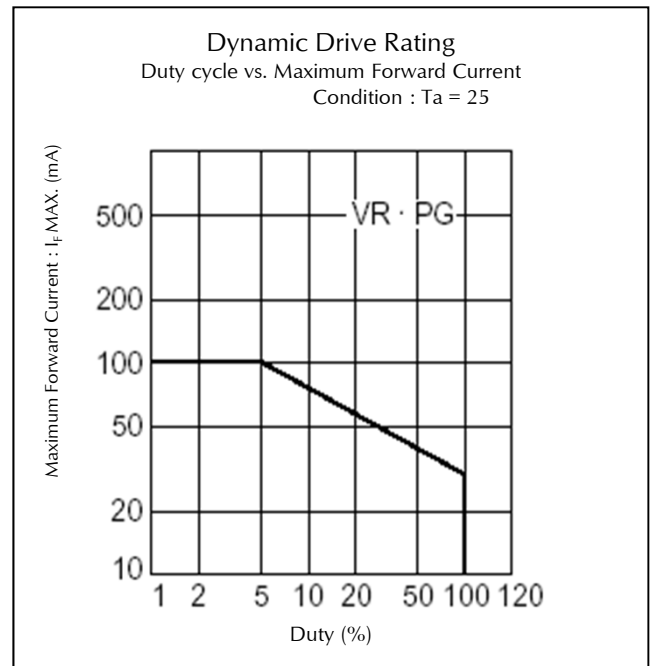
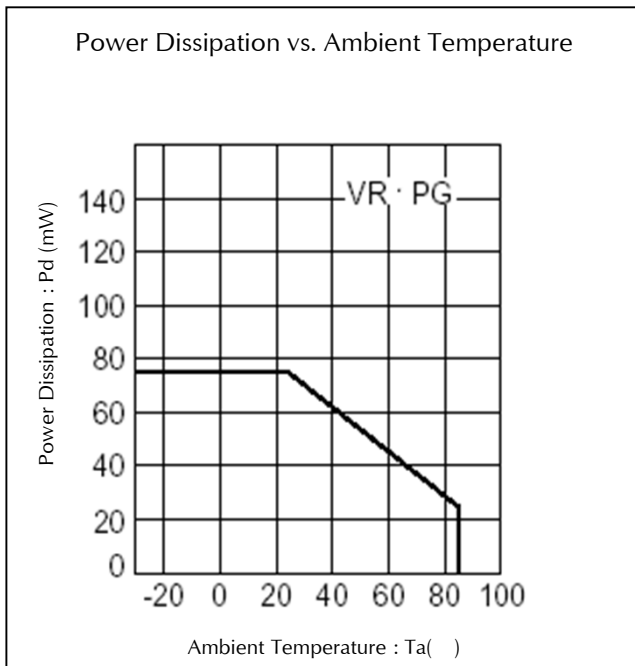
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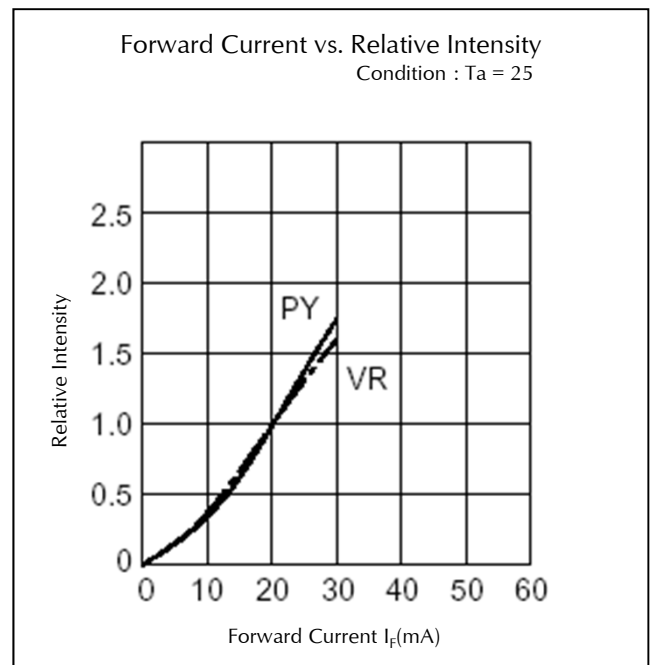
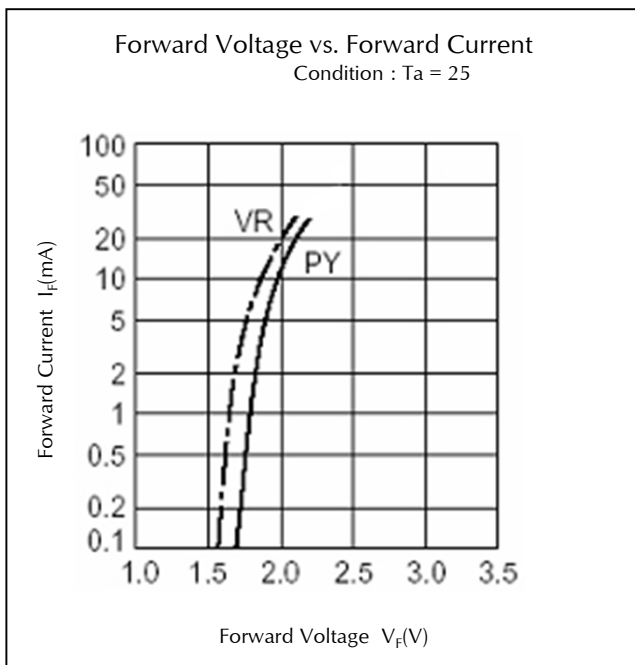
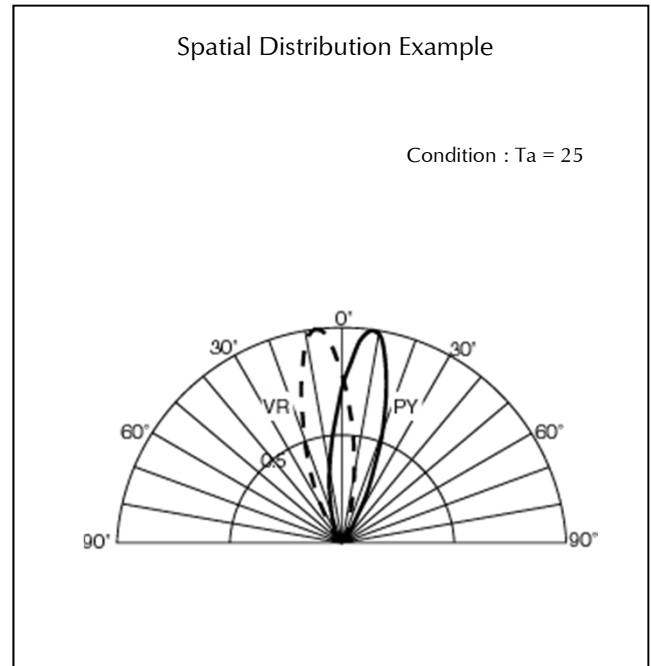
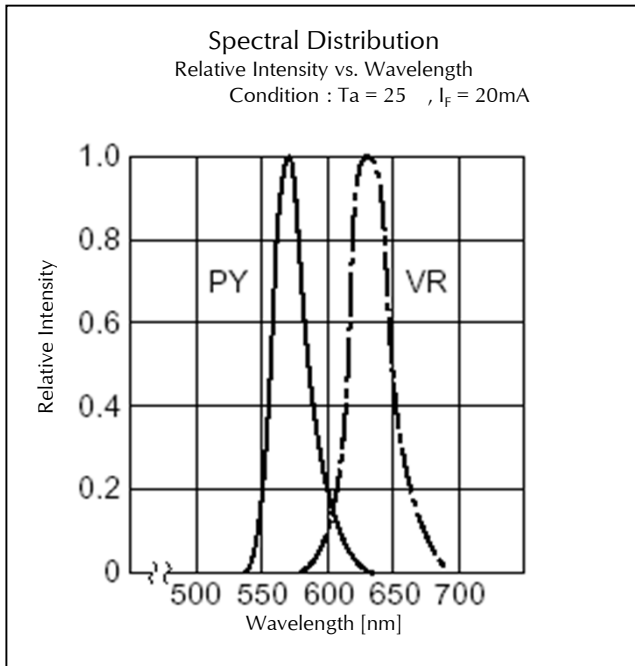
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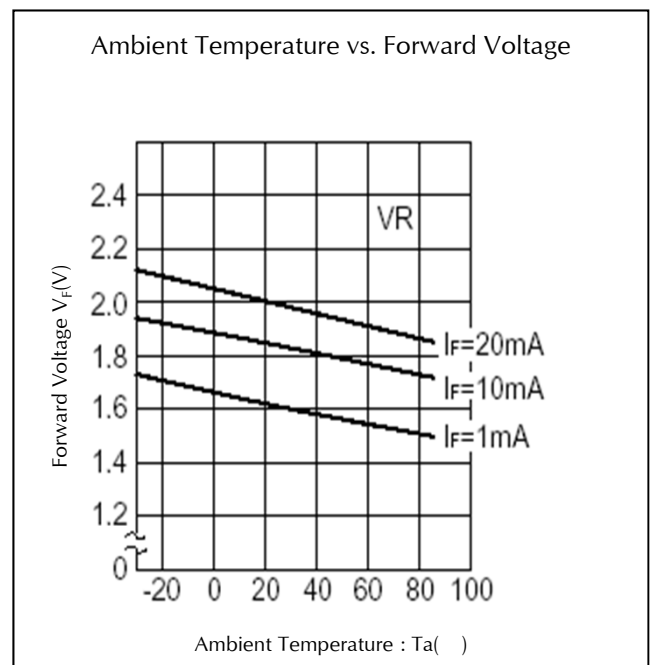
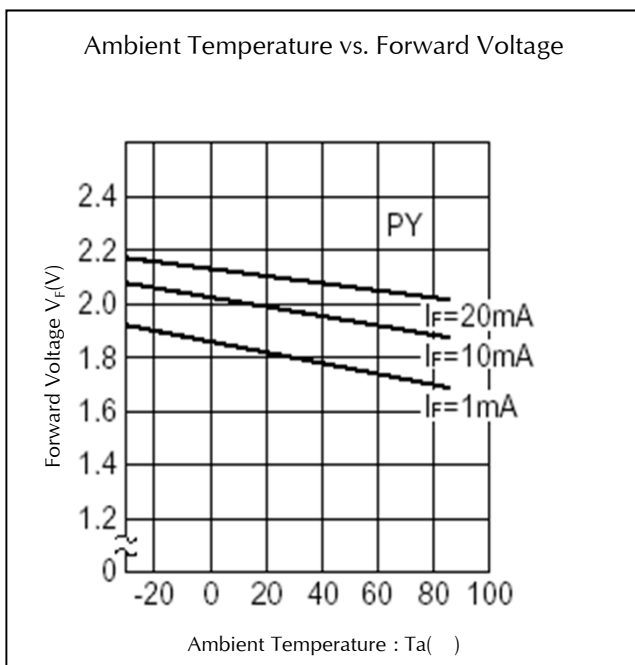
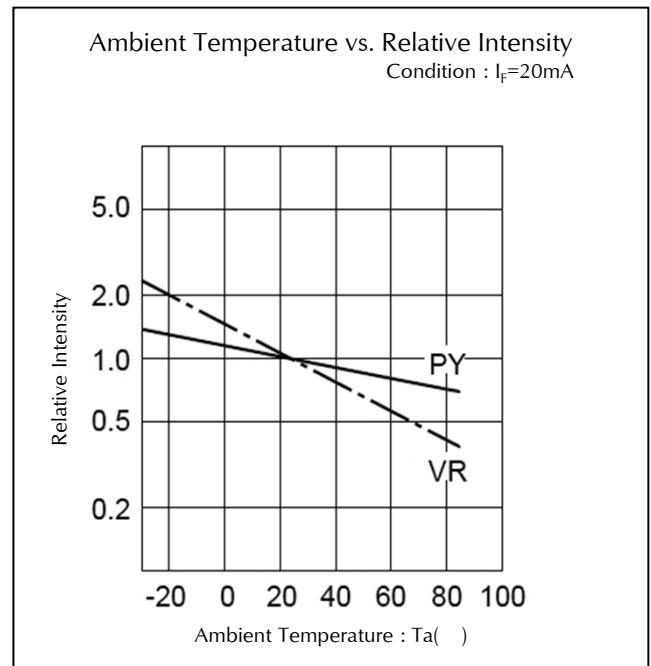
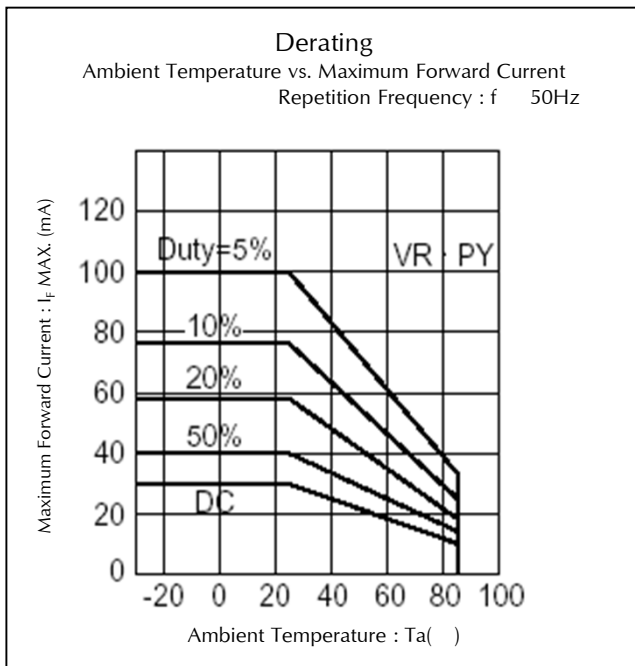
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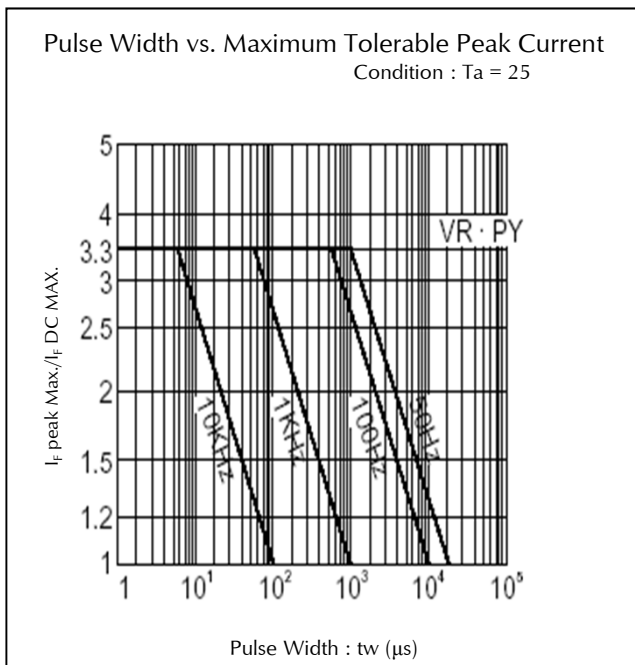
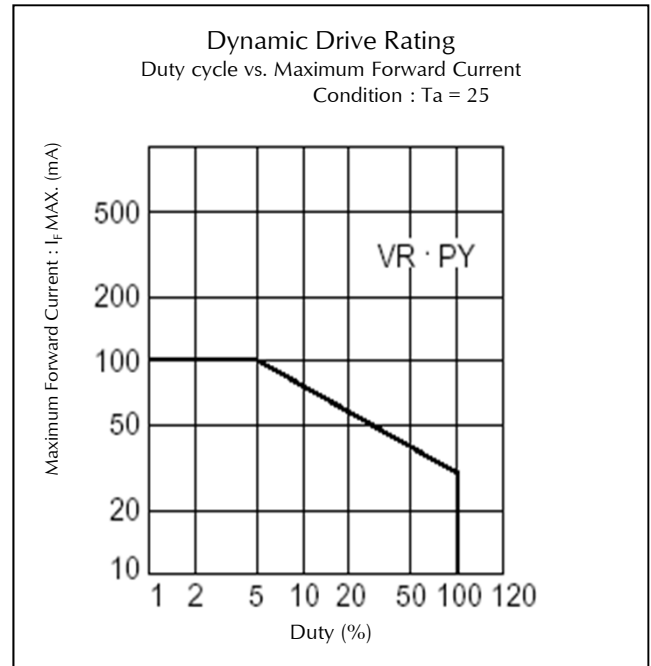
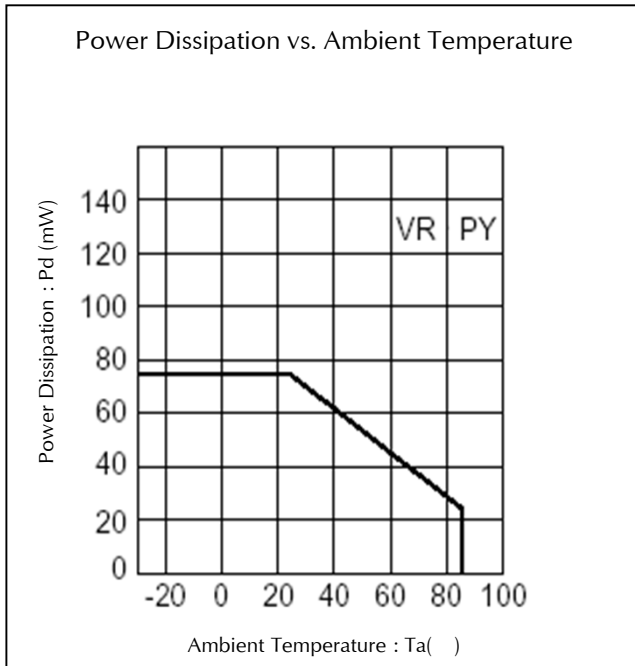
Technical Data(VRPY)



Technical Data(VRPY)



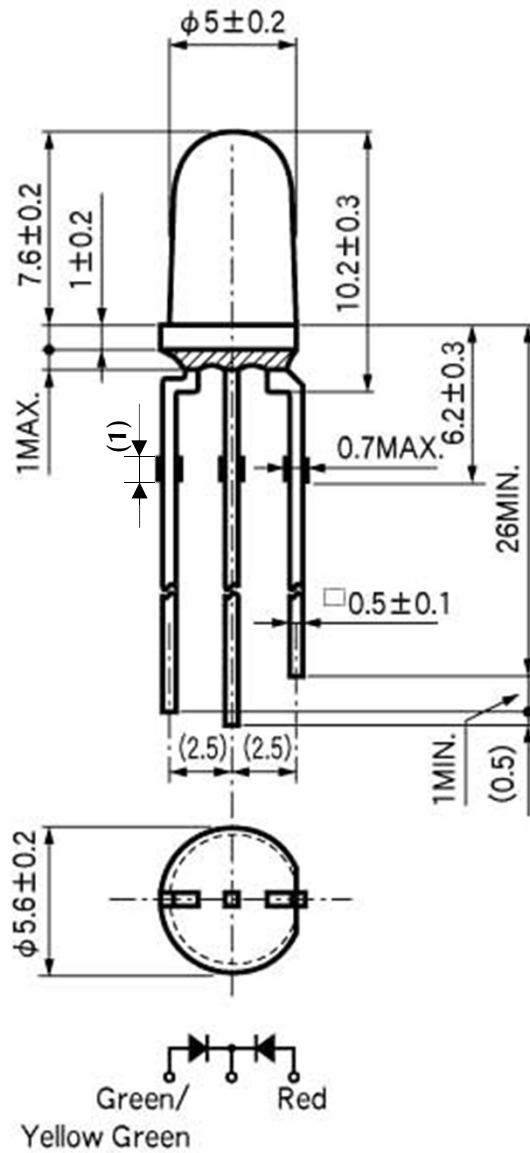
Technical Data(VRPY)



Package Dimensions

(Unit: mm)

Mass : (0.38)g



TTW (Through The Wave) soldering Conditions

Pre-heating	100	(MAX.)
Solder Bath Temp.	265	(MAX.)
Dipping Time	5 s	(MAX.)

- 1) The dip soldering process shall be 2 times maximum.
- 2) The product shall be cooled to room temp. before the second dipping process.

The detail is described to LED and Photodetector handling precautions of home page:
 "Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.

Manual Soldering Conditions

Iron tip temp.	360	(MAX.)
Soldering time and frequency	3 s	(MAX.)
	2 times	(MAX.)

The detail is described to LED and Photodetector handling precautions of home page:
 "Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(302)	260±5°C, 3mm from package base	10s	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Lead Tension	EIAJ ED-4701/400(401)	10N, 1time (□0.4 and Flat Package : 5N)	10s	0/10
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking

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